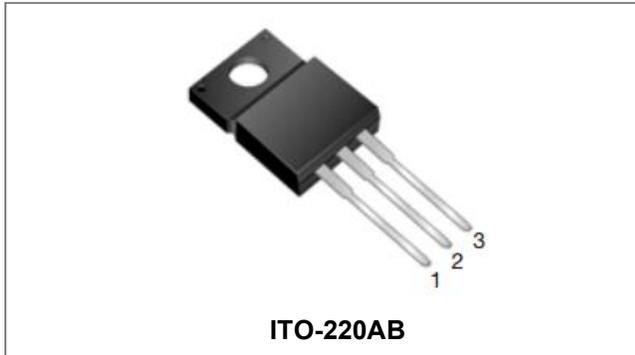


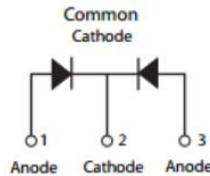
MBRF16100CT SCHOTTKY RECTIFIER



Features

- 150°C T_J operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Maximum Ratings:

| Characteristics | Symbol | Condition | Max. | Units |
|--|--------------------|--|------------------------------|-------|
| Peak Repetitive Reverse Voltage | V _{RRM} | - | 200 | V |
| Working Peak Reverse Voltage | V _{RWM} | | | |
| DC Blocking Voltage | V _R | | | |
| Average Rectified Forward Current | I _{F(AV)} | 50% duty cycle @T _c =133°C, rectangular wave form | 8(Per Leg) 16(Per Device) | A |
| Peak One Cycle Non-Repetitive Surge Current(Per Leg) | I _{FSM} | 8.3ms, Half Sine pulse | 180 | A |

Electrical Characteristics:

| Characteristics | Symbol | Condition | Typ. | Max. | Units |
|--|------------------|---|-------|--------|-------|
| Forward Voltage Drop (Per Leg)* | V _{F1} | @ 8 A, Pulse, T _J = 25 °C | 0.74 | 0.78 | V |
| | | @ 16 A, Pulse, T _J = 25 °C | 0.80 | 0.85 | |
| Reverse Current at DC condition (Per Leg)* | I _{R1} | @V _R = rated V _R , T _J = 25 °C | 0.006 | 1.0 | mA |
| | | @V _R = rated V _R , T _J = 125 °C | 1 | 5.0 | |
| Junction Capacitance(Per Leg) | C _T | @V _R = 5V, T _C = 25 °C, f _{SIG} = 1MHz | 300 | 400 | pF |
| Series Inductance(Per Leg) | L _S | Measured lead to lead 5 mm from package body | 8.0 | - | nH |
| Voltage Rate of Change | dv/dt | - | - | 10,000 | V/μs |
| RSM Isolation Voltage (t = 1.0 second, R. H. < =30%, T _A = 25 °C) | V _{ISO} | Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction. | - | 4500 | V |
| | | Clip mounting, the epoxy body is inside the heatsink. | - | 3500 | |

Technical Data
Data Sheet N0846, Rev. A



| | | | | | |
|--|--|--|---|------|--|
| | | Screw mounting, the epoxy body is inside the heatsink. | - | 1500 | |
|--|--|--|---|------|--|

* Pulse width < 300 μ s, duty cycle < 2%

Thermal-Mechanical Specifications:

| Characteristics | Symbol | Condition | Specification | Units |
|--|-----------------|--------------|---------------|----------------|
| Junction Temperature | T_J | - | -55 to +150 | $^{\circ}$ C |
| Storage Temperature | T_{stg} | - | -55 to +150 | $^{\circ}$ C |
| Typical Thermal Resistance Junction to Case(Per Leg) | $R_{\theta JC}$ | DC operation | 3.5 | $^{\circ}$ C/W |
| Approximate Weight | wt | - | 2 | g |

Ratings and Characteristics Curves

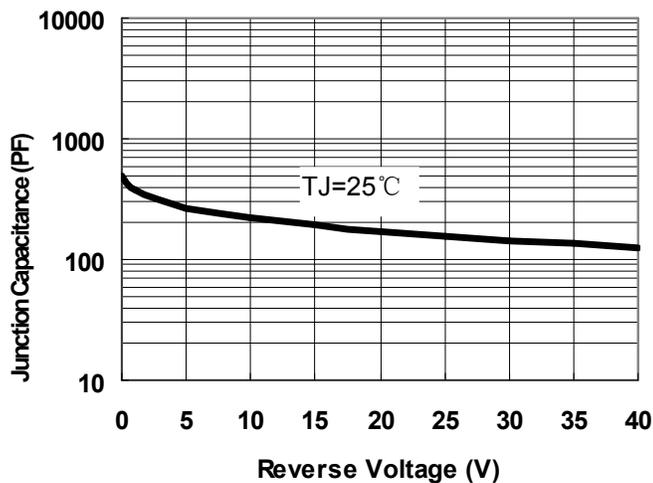


Fig.1-Typical Junction Capacitance

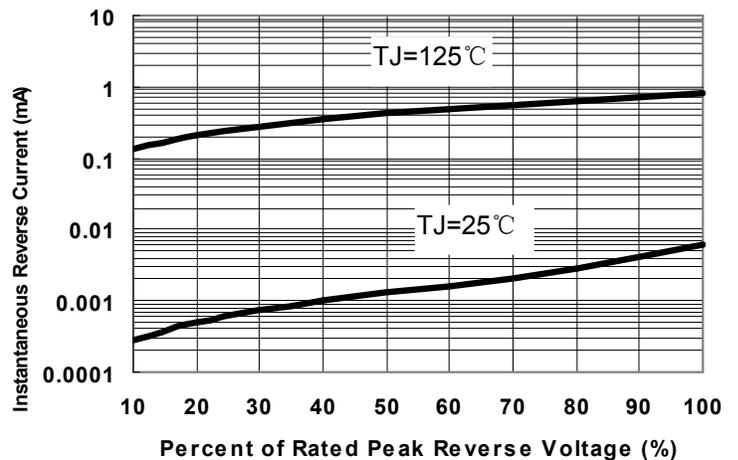


Fig.2-Typical Reverse Characteristics

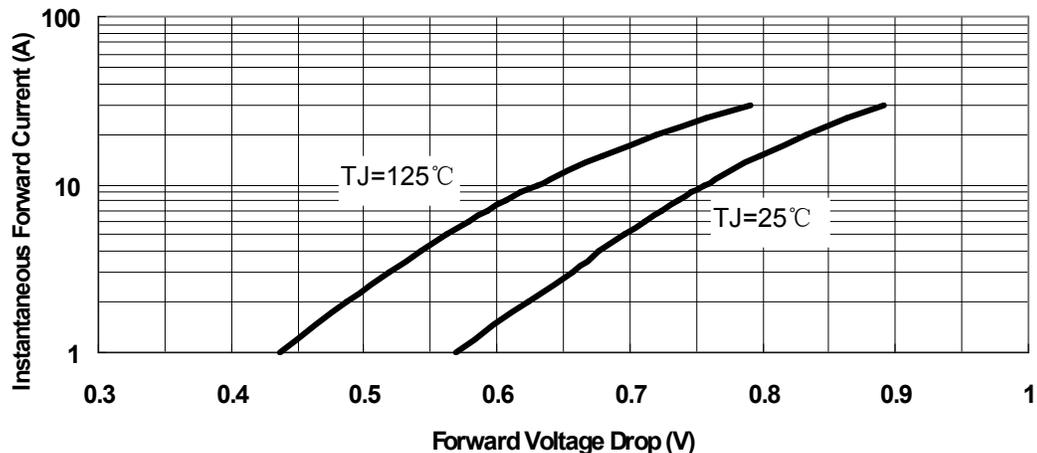
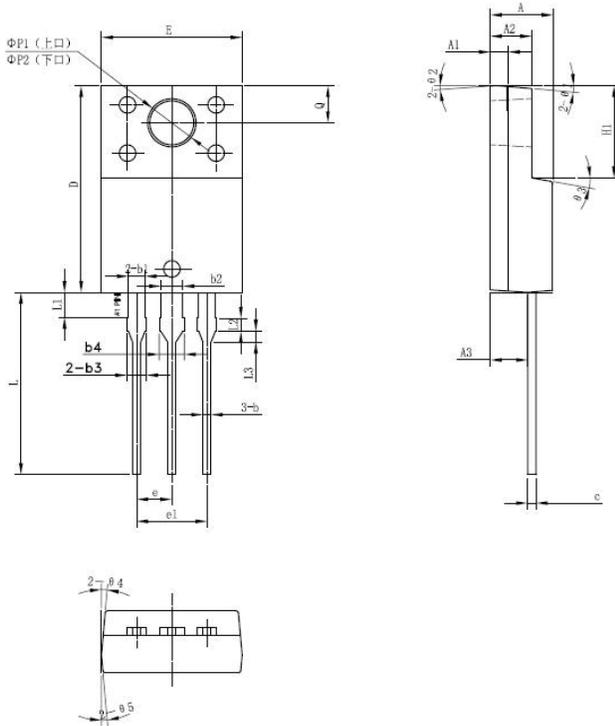


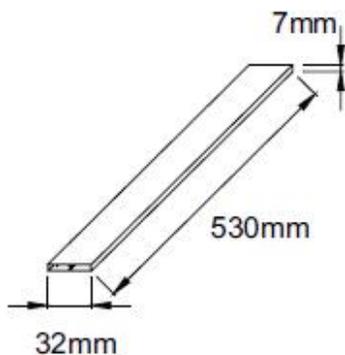
Fig.3-Typical Instantaneous Forward Voltage Characteristics

Mechanical Dimensions ITO-220AB

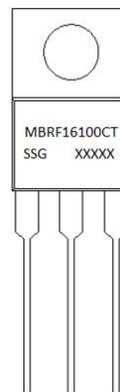


| SYMBOL | Millimeters | | |
|---------|-------------|-------|-------|
| | MIN. | TYP. | MAX. |
| A | 4.30 | 4.50 | 4.70 |
| A1 | 1.10 | 1.30 | 1.50 |
| A2 | 2.80 | 3.00 | 3.20 |
| A3 | 2.50 | 2.70 | 2.90 |
| b | 0.50 | 0.60 | 0.75 |
| b1 | 1.10 | 1.20 | 1.35 |
| b2 | 1.50 | 1.60 | 1.75 |
| b3 | 1.20 | 1.30 | 1.45 |
| b4 | 1.60 | 1.70 | 1.85 |
| c | 0.50 | 0.60 | 0.75 |
| D | 14.80 | 15.00 | 15.20 |
| E | 9.96 | 10.16 | 10.36 |
| e | | 2.55 | |
| e1 | | 5.10 | |
| H1 | 6.50 | 6.70 | 6.90 |
| L | 12.70 | 13.20 | 13.70 |
| L1 | 1.60 | 1.80 | 2.00 |
| L2 | 0.80 | 1.00 | 1.20 |
| L3 | 0.60 | 0.80 | 1.00 |
| ΦP1(上口) | 3.30 | 3.50 | 3.70 |
| ΦP2(下口) | 2.99 | 3.19 | 3.39 |
| Q | 2.50 | 2.70 | 2.90 |
| Θ1 | | 5° | |
| Θ2 | | 4° | |
| Θ3 | | 10° | |
| Θ4 | | 5° | |
| Θ5 | | 5° | |

Tube Specification



Marking Diagram



Where XXXXX is YYWWL

- MBR = Device Type
- F = Package type
- 16 = Forward Current (16A)
- 100 = Reverse Voltage (100V)
- CT = Configuration
- SSG = SSG
- YY = Year
- WW = Week
- L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Ordering Information

| Device | Package | Shipping |
|-------------|------------------------|--------------|
| MBRF16100CT | ITO-220AB (Pb-Free) | 50 pcs/ tube |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

- China - Germany - Korea - Singapore - United States •
- <http://www.smc-diodes.com> - sales@smc-diodes.com •

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